

1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Product Summary (@ TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)
600	1	1.7	5
400	1	1.3	5
200	1	0.98	5

Features and Benefits

- Low Profile, Small Form Factor Package
- Low Leakage Current
- Glass Passivated for High Reliability
- Superfast Recovery Times for High Efficiency
- Low Forward Voltage, Low Power Loss
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

The SF1xDF is a rectifier packaged in D-FLAT and is suited as a boost diode in power factor correction circuitry. For use in secondary rectification and freewheeling for superfast switching speed AC-DC and DC-DC converters in high-temperature conditions for consumer applications.

- DC-DC Converters
- AC-DC Adaptors/Chargers
- Inverters

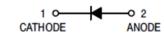
Mechanical Data

- Case: D-FLAT
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.062 grams (Approximate)

D-FLAT



Top View



Schematic View

Ordering Information (Note 4)

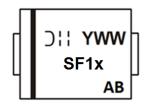
Part Number	Qualification	Case	Packaging
SF1JDF-13	Commercial	D-FLAT	10,000/Tape & Reel
SF1GDF-13	Commercial	D-FLAT	10,000/Tape & Reel
SF1DDF-13	Commercial	D-FLAT	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

D-FLAT



SF1x = Product Type Marking Code (ie. SF1J for SF1JDF, SF1G for SF1GDF, SF1D for SF1DDF)

| SF1JDF, SF1G for SF1GDF, SF1D for SF1DDF)
| SF1JDF, SF1D for SF1DDF)
| SF1JDF, SF1D for SF1DDF)
| WW = Marking
| Y = Last Digit of Year (ex: 6 for 2016)
| WW = Week Code (01 to 53)
| AB = Foundry and Assembly Code



Maximum Ratings and Electrical Characteristics (@TA = +25°C unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	SF1DDF	SF1GDF	SF1JDF	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	400	600	V
Average Rectified Output Current @T _T = +110°C (Note 5)	lo		1.0		Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}		30		А
Maximum Instantaneous Forward Voltage @ I _F = 1A	V_{F}	0.98	1.3	1.7	V
Maximum DC Reverse Current @ $T_A = +25$ °C at Rated DC Blocking Voltage @ $T_A = +100$ °C (Note 7)	I _R		5 100		μΑ
Typical Total Capacitance (Note 8)	Ст		20		pF
Maximum Reverse Recovery Time (Note 9)	t _{RR}		35		ns

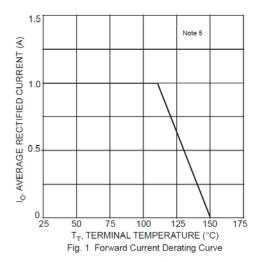
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Terminal (Note 6)	R _{OJT}	36	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	Reja	87	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 5.Device mounted on FR-4 substrate, 1" \times 1", 2oz, single-sided, PCBs with 0.1" \times 0.15" copper pad. 6. Device mounted on FR-4 substrate, 0.4" \times 0.5", 2oz, single-sided, PC boards with 0.2" \times 0.25" copper pad.
- 7. Short duration pulse test used to minimize self-heating effect. 8. Measured at 1.0MHZ and applied reverse voltage of 4.0V DC.
- 9. Measured with IF = 0.5A, IR = 1A, IRR = 0.25A.





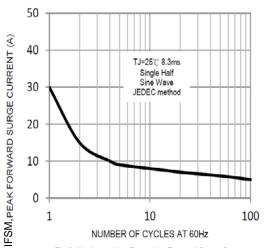
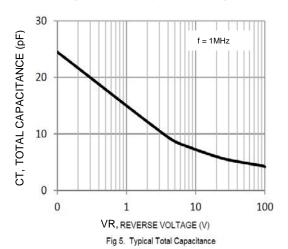


Fig 3. Maximum Non-Repetitive Forward Surge Current



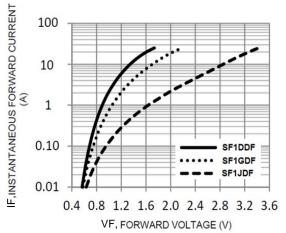
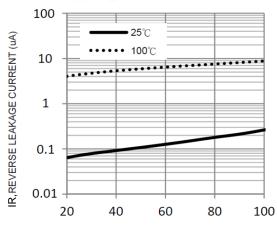


Fig. 2. Typical Forward Characteristics



VR, PERCENTAGE RATED PEAK REVERSE VOLTAGE (%)
Fig 4. Typical Reverse Characteristics

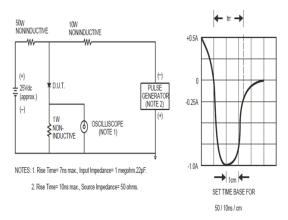


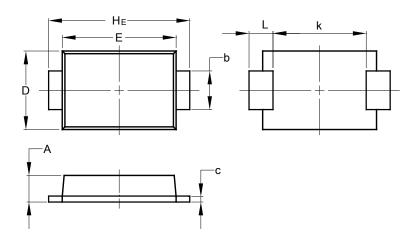
Fig 6. Reverse Recovery Time Characteristic and Test Circuit



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

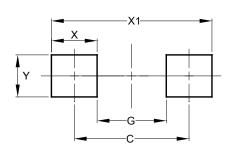
D-FLAT



D-FLAT			
Dim	Min	Max	
Α	0.90	1.10	
b	1.25	1.65	
С	0.10	0.40	
D	2.25	2.95	
Е	3.95	4.60	
k	2.80	-	
HE	5.00	5.60	
L	0.50	1.30	
All Dimensions in mm			

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$



D-FLAT

Dimensions	Value (in mm)	
С	4.65	
G	2.80	
Х	1.85	
X1	6.50	
Υ	1 70	



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